

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Masato Nomiya et al.

Allowed: April 10, 2009

Application No.: 10/576,801

Confirmation No.: 5833

Filed: April 21, 2006

Art Unit: 1796

For: ELECTRICALLY CONDUCTIVE PASTE AND
MULTILAYER CERAMIC SUBSTRATE

Examiner: K. T. Nguyen

LETTER

Attn: MS Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Madam:

Applicants respectfully re-submit a copy of the references filed with the Information Disclosure Statement of May 9, 2008. The SB 0/8 (Form PTO-1449), and Korean Office Action with English translation dated March 31, 2008 that were submitted along with the said IDS are also enclosed for the Office's convenience.

A formal acknowledgement of the references is respectfully requested before the issue fee payment due date of July 10, 2009.

Please charge any credits or deficiencies to our Deposit Account No.: 50-2215.

Dated: May 18, 2009

Respectfully submitted,

By


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